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April 1998

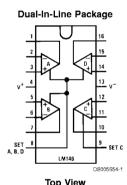
National Semiconductor

LM146/LM246/LM346 Programmable Quad Operational Amplifiers

General Description

The LM146 series of quad op amps consists of four independent, high gain, internally compensated, low power, programmable amplifiers. Two external resistors (R_{SET}) allow the user to program the gain bandwidth product, slew rate, supply current, input bias current, input offset current and input noise. For example, the user can trade-off supply current for bandwidth or optimize noise figure for a given source resistance. In a similar way, other amplifier characteristics can be tailored to the application. Except for the two programming pins at the end of the package, the LM146 pin-out is the same as the LM124 and LM148.

Connection Diagram



Top View Order Number LM146J, LM146J/883, LM246J, LM346M or LM346N See NS Package Number J16A, M16A or N16A

Features

- (I_{SET}=10 µA) ■ Programmable electrical characteristics
- Battery-powered operation
- Low supply current: 350 µA/amplifier
- Guaranteed gain bandwidth product: 0.8 MHz min
- Large DC voltage gain: 120 dB
- Low noise voltage: 28 nV/√Hz
- Wide power supply range: ±1.5V to ±22V
- Class AB output stage-no crossover distortion
- Ideal pin out for Biquad active filters
- Input bias currents are temperature compensated

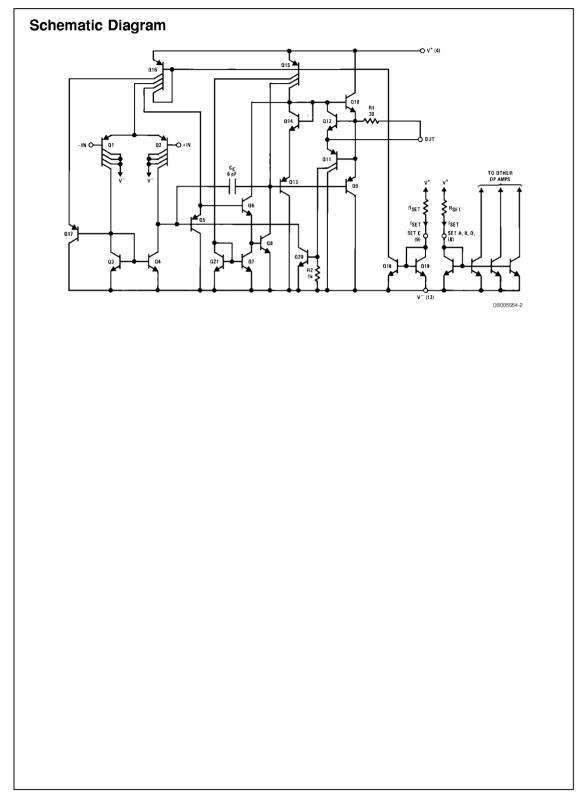
PROGRAMMING EQUATIONS

Total Supply Current = 1.4 mA ($I_{SET}/10 \mu A$) Gain Bandwidth Product = 1 MHz ($I_{SET}/10 \mu A$) Slew Rate = 0.4V/µs ($I_{SET}/10 \mu A$) Input Bias Current $\equiv 50 nA (I_{SET}/10 \mu A)$ I_{SET} = Current into pin 8, pin 9 (see schematic-diagram)

$$I_{\text{SET}} = \frac{V^+ - V^- - 0.6V}{R_{\text{SET}}}$$

_M146/LM246/LM346 Programmable Quad Operational Amplifiers

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Absolute Maximum Ratings (Notes 1, 5)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

	LM146	LM246	LM346
Supply Voltage	±22V	±18V	±18V
Differential Input Voltage (Note 1)	±30V	±30V	±30V
CM Input Voltage (Note 1)	±15V	±15V	±15V
Power Dissipation (Note 2)	900 m W	500 m W	500 m W
Output Short-Circuit Duration (Note 3)	Continuous	Continuous	Continuous
Operating Temperature Range	–55°C to +125°C	–25°C to +85°C	0°C to +70°C
Maximum Junction Temperature	150°C	110°C	100°C
Storage Temperature Range	−65°C to +150°C	–65°C to +150°C	–65°C to +150°C
Lead Temperature (Soldering, 10 seconds)	260°C	260°C	260°C
Thermal Resistance (θ_{iA}), (Note 2)			
Cavity DIP (J) Pd	900 m W	900 m W	900 m W
θ_{iA}	100°C/W	100°C/W	100°C/W
Small Outline (M) θ _{iA}			115°C/W
Molded DIP (N) Pd			500 m W
θ_{iA}			90°C/W
Soldering Information			
Dual-In-Line Package			
Soldering (10 seconds)	+260°C	+260°C	+260°C
Small Outline Package			
Vapor Phase (60 seconds)	+215°C	+215°C	+215°C
Infrared (15 seconds)	+220°C	+220°C	+220°C

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

ESD rating is to be determined.

DC Electrical Characteristics (V_s= $\pm 15V$, I_s= $\pm 10 \mu A$), (Note 4)

Parameter	Conditions	LM146			LM246/LM346			Units
		Min	Тур	Max	Min	Тур	Max	
Input Offset Voltage	V _{CM} =0V, R _S ≤50Ω, T _A =25°C		0.5	5		0.5	6	mV
Input Offset Current	V _{CM} =0V, T _A =25°C		2	20		2	100	nA
Input Bias Current	V _{CM} =0V, T _A =25°C		50	100		50	250	nA
Supply Current (4 Op Amps)	T _A =25°C		1.4	2.0		1.4	2.5	mA
Large Signal Voltage Gain	$R_L=10$ kΩ, $\Delta V_{OUT}=\pm 10V$, $T_A=25$ °C	100	1000		50	1000		V/mV
Input CM Range	T _A =25°C	±13.5	±14		±13.5	±14		V
CM Rejection Ratio	R _s ≤10 kΩ, T _A =25°C	80	100		70	100		dB
Power Supply Rejection Ratio	R_{S} ≤10 kΩ, T_{A} =25°C, V _S = ±5 to ±15V	80	100		74	100		dB
Output Voltage Swing	R _L ≥10 kΩ, T _A =25°C	±12	±14		±12	±14		V
Short-Circuit	T _A =25°C	5	20	35	5	20	35	mA
Gain Bandwidth Product	T _A =25°C	0.8	1.2		0.5	1.2		MHz
Phase Margin	T _A =25°C		60			60		Deg
Slew Rate	T _A =25°C		0.4			0.4		V/µs
Input Noise Voltage	f=1 kHz, T _A =25°C		28			28		nV/√Hz
Channel Separation	R _L =10 kΩ, ΔV_{OUT} =0V to ±12V, T _A =25°C		120			120		dB
Input Resistance	T _A =25°C		1.0	1		1.0		MΩ
Input Capacitance	T _A =25°C		2.0			2.0		pF
Input Offset Voltage	V _{CM} =0V, R _S ≤50Ω		0.5	6		0.5	7.5	mV

DC Electrical Characteristics (Continued)

(V _S =±15V, I _{SET} =10 µA), (Note 4)									
Parameter	Conditions	LM146			LM246/LM346			Units	
		Min	Тур	Max	Min	Тур	Max		
Input Offset Current	V _{CM} =0V		2	25		2	100	nA	
Input Bias Current	V _{CM} =0V		50	100		50	250	nA	
Supply Current (4 Op Amps)			1.7	2.2		1.7	2.5	mA	
Large Signal Voltage Gain	R _L =10 kΩ, Δ V _{OUT} =±10V	50	1000		25	1000		V/mV	
Input CM Range		±13.5	±14		±13.5	±14		V	
CM Rejection Ratio	R _s ≤50Ω	70	100		70	100		dB	
Power Supply Rejection Ratio	R _S ≤50Ω,	76	100		74	100		dB	
	$V_{\rm S} = \pm 5V$ to $\pm 15V$								
Output Voltage Swing	R _L ≥10 kΩ	±12	±14		±12	±14		V	

DC Electrical Characteristic

(V_S=±15V, I_{SET}=10 µA)

Parameter	Conditions	LM146			LI	Units		
		Min	Тур	Max	Min	Тур	Max	
Input Offset Voltage	V _{CM} =0V, R _S ≤50Ω, T _A =25°C		0.5	5		0.5	7	mV
Input Bias Current	V _{CM} =0V, T _A =25°C		7.5	20		7.5	100	nA
Supply Current (4 Op Amps)	T _A =25°C		140	250		140	300	μA
Gain Bandwidth Product	T _A =25°C	80	100		50	100		kHz

DC Electrical Characteristics

(V_S=±1.5V, I_{SET}=10 µA)

Parameter	Conditions	LM146			LN	Units		
		Min	Тур	Max	Min	Тур	Max	
Input Offset Voltage	V _{CM} =0V, R _S ≤50Ω,		0.5	5		0.5	7	mV
	T _A =25°C							
Input CM Range	T _A =25°C	±0.7			±0.7			V
CM Rejection Ratio	R _s ≤50Ω, T _A =25°C		80			80		dB
Output Voltage Swing	R _L ≥10 kΩ, T _A =25°C	±0.6			±0.6			V

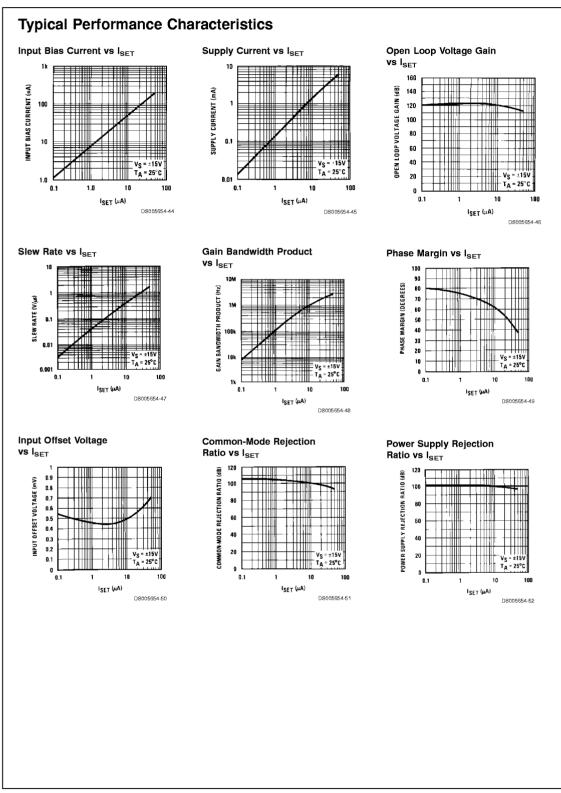
Note 1: For supply voltages less than ±15V, the absolute maximum input voltage is equal to the supply voltage.

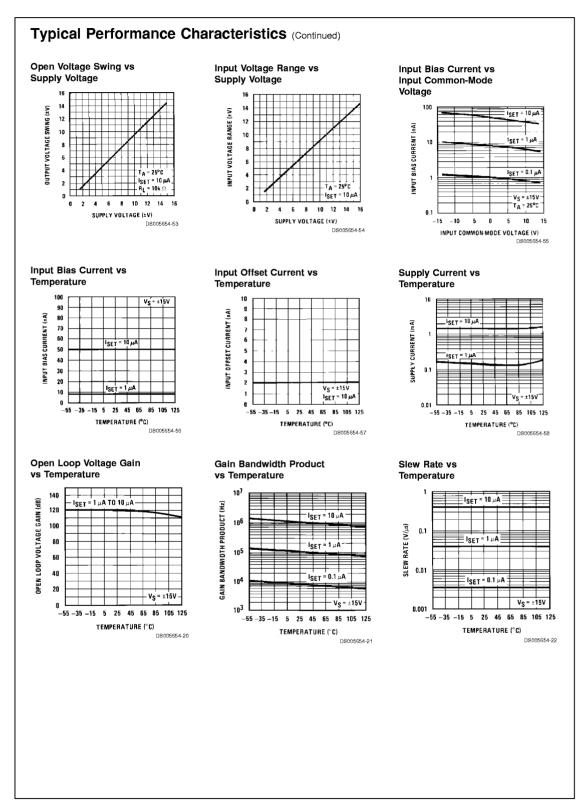
Note 2: The maximum power dissipation for these devices must be derated at elevated temperatures and is dictated by T_{jMAX} . θ_{jA} , and the ambient temperature, T_A . The maximum available power dissipation at any temperature is $P_d=(T_{jMAX} - T_A)/\theta_{jA}$ or the 25'C P_{dMAX} , whichever is less.

Note 3: Any of the amplifier outputs can be shorted to ground indefinitely; however, more than one should not be simultaneously shorted as the maximum junction temperature will be exceeded.

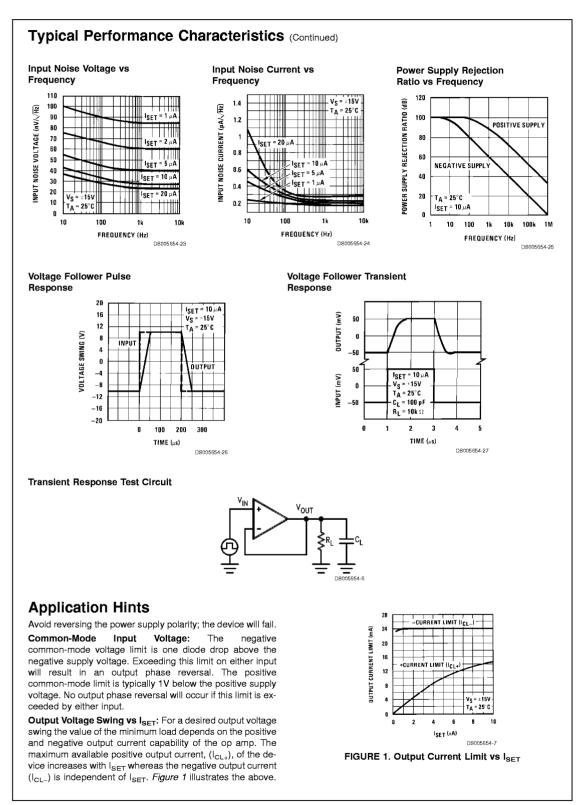
Note 4: These specifications apply over the absolute maximum operating temperature range unless otherwise noted.

Note 5: Refer to RETS146X for LM146J military specifications.



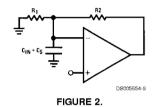


6



Application Hints (Continued)

Input Capacitance: The input capacitance, $C_{\rm IN}$, of the LM146 is approximately 2 pF; any stray capacitance, $C_{\rm S}$, (due to external circuit circuit layout) will add to $C_{\rm IN}$. When resistive or active feedback is applied, an additional pole is added to the open loop frequency response of the device. For instance with resistive feedback (*Figure 2*), this pole occurs at $^{\prime} 2\pi$ (R1||R2) ($C_{\rm IN} + C_{\rm S}$). Make sure that this pole occurs at least 2 octaves beyond the expected –3 dB frequency corner of the closed loop gain of the amplifier; if not, place a lead capacitor in the feedback such that the time constant of this capacitor and the resistance it parallels is equal to the R_I(C_S + C_{IN}), where R_I is the input resistance of the circuit.

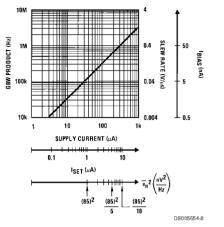


Temperature Effect on the GBW: The GBW (gain bandwidth product), of the LM146 is directly proportional to I_{SET} and inversely proportional to the absolute temperature. When using resistors to set the bias current, I_{SET} , of the device, the GBW product will decrease with increasing temperature. Compensation can be provided by creating an I_{SET} current directly proportional to temperature (see typical applications).

Isolation Between Amplifiers: The LM146 die is isothermally layed out such that crosstalk between *all* 4 amplifiers is in excess of -105 dB (DC). Optimum isolation (better than -110 dB) occurs between amplifiers A and D, B and C; that is, if amplifier A dissipates power on its output stage, amplifier D is the one which will be affected the least, and vice versa. Same argument holds for amplifiers B and C.

LM146 Typical Performance Summary: The LM146 typical behaviour is shown in *Figure 3*. The device is fully predictable. As the set current, I_{SET} , increases, the speed, the bias current, and the supply current increase while the noise

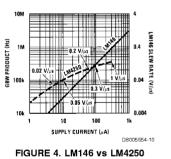
power decreases proportionally and the $V_{OS} {\rm remains}$ constant. The usable GBW range of the op amp is 10 kHz to 3.5-4 MHz.

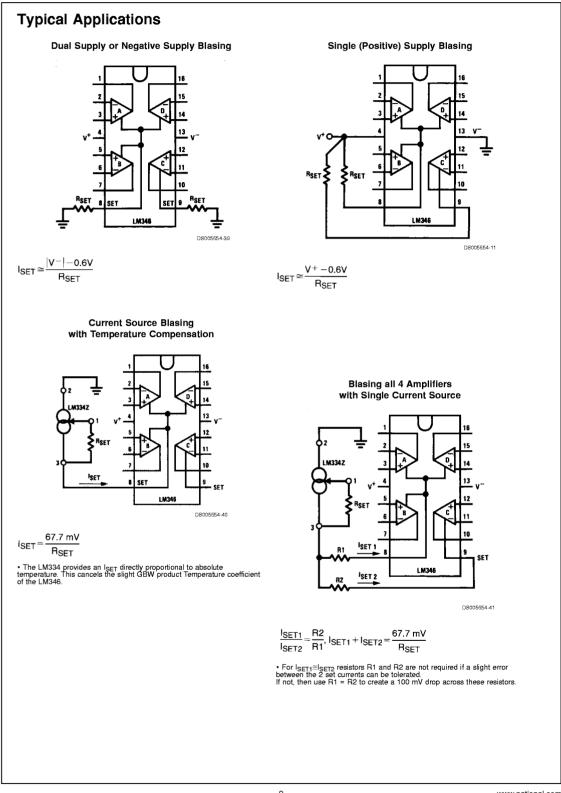


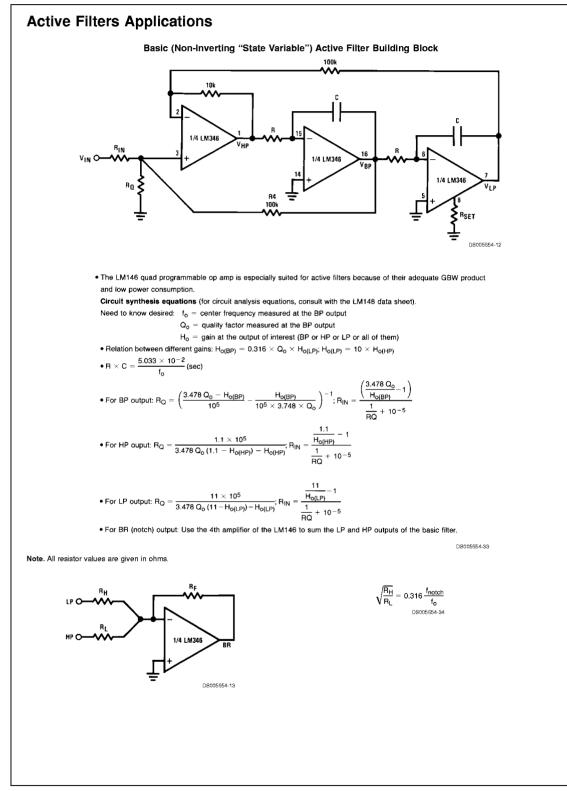


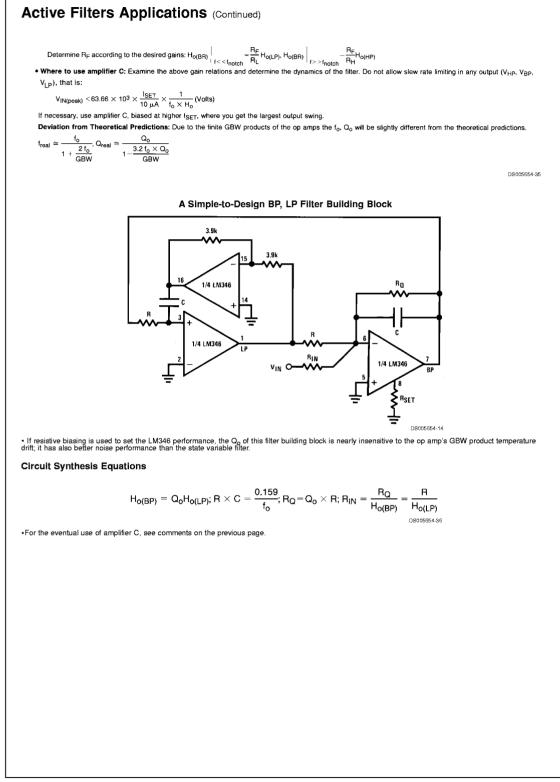
Low Power Supply Operation: The quad op amp operates down to $\pm 1.3V$ supply. Also, since the internal circuitry is biased through programmable current sources, no degradation of the device speed will occur.

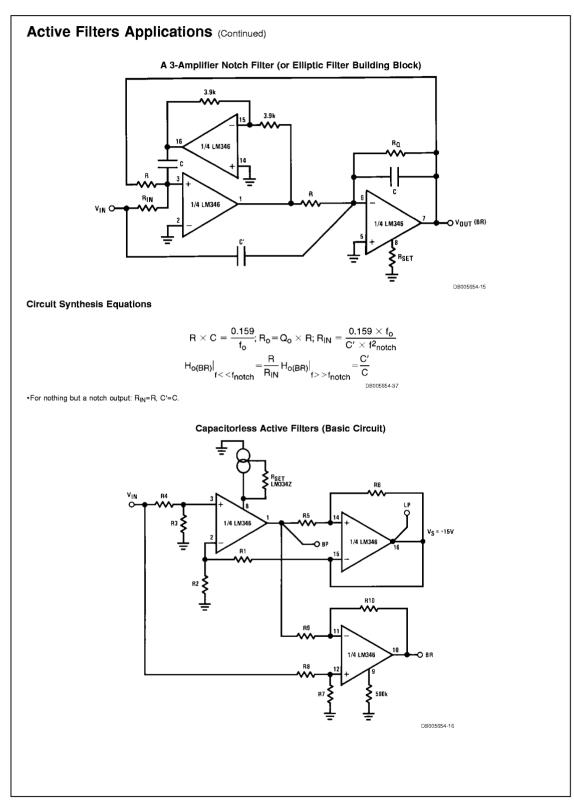
Speed vs Power Consumption: LM146 vs LM4250 (single programmable). Through *Figure 4*, we observe that the LM146's power consumption has been optimized for GBW products above 200 kHz, whereas the LM4250 will reach a GBW of no more than 300 kHz. For GBW products below 200 kHz, the LM4250 will consume less power.

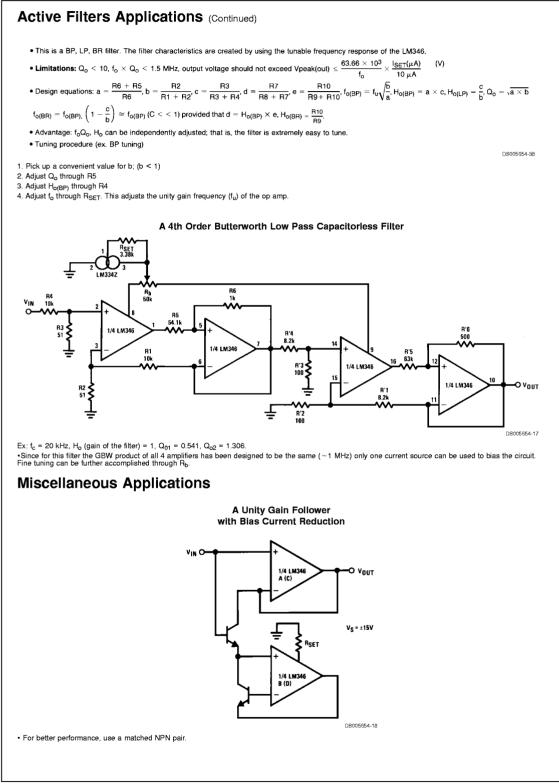




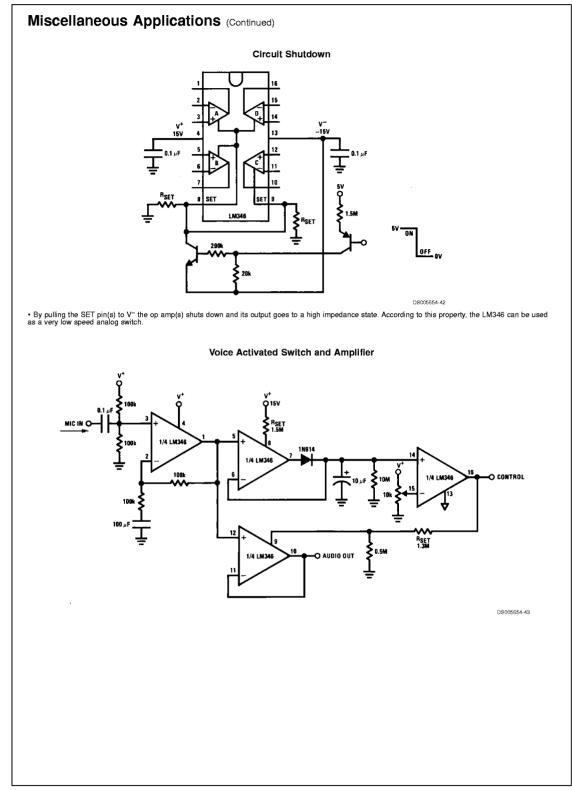




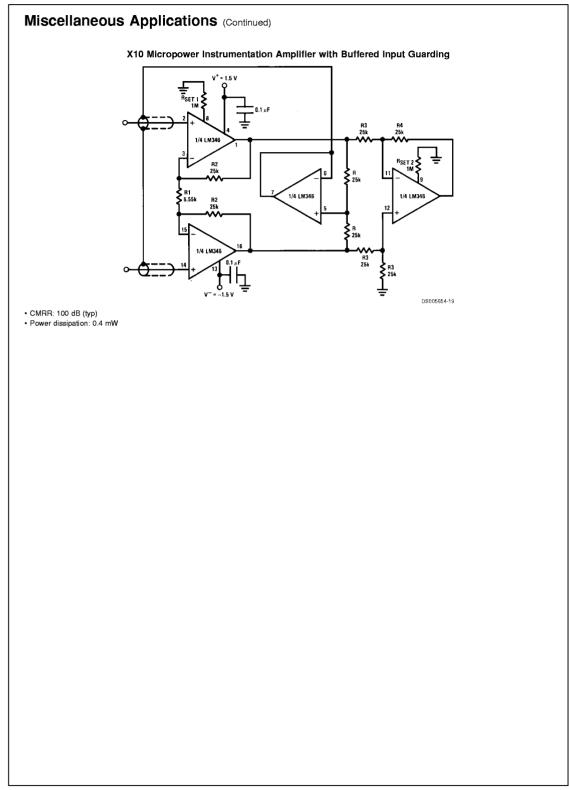


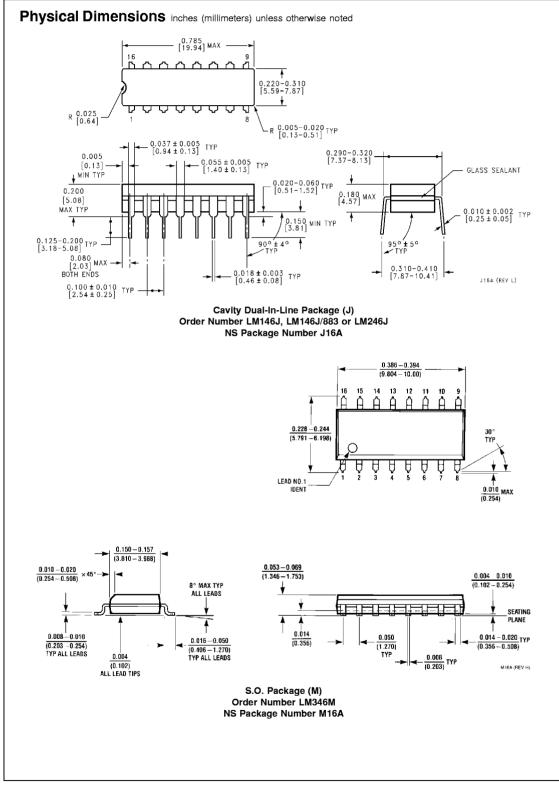


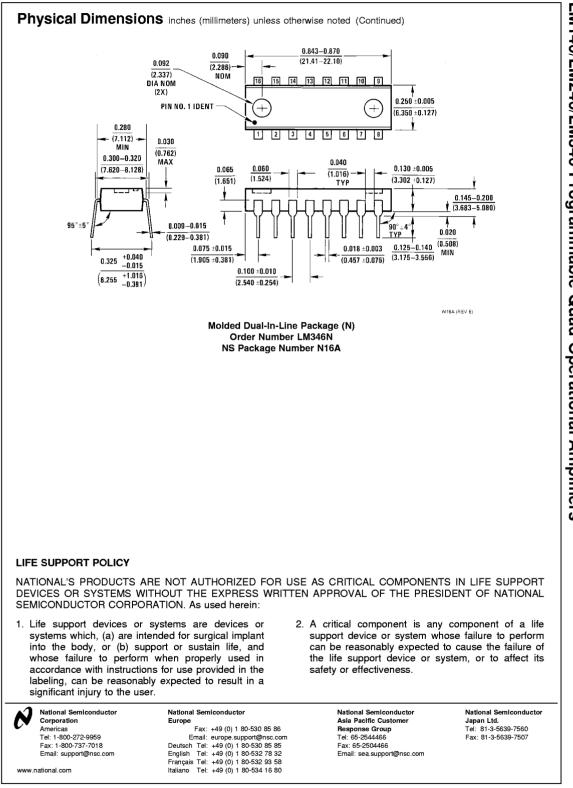
13



14







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